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MM74HC573 3-STATE Octal D-Type Latch

General Description

The MM74HC573 high speed octal D-type latches utilize advanced silicon-gate P-well CMOS technology. They possess the high noise immunity and low power consumption of standard CMOS integrated circuits, as well as the ability to drive 15 LS-TTL loads. Due to the large output drive capability and the 3-STATE feature, these devices are ideally suited for interfacing with bus lines in a bus organized system.

When the LATCH ENABLE(LE) input is HIGH, the Q outputs will follow the D inputs. When the LATCH ENABLE goes LOW, data at the D inputs will be retained at the outputs until LATCH ENABLE returns HIGH again. When a HIGH logic level is applied to the OUTPUT CONTROL OC input, all outputs go to a HIGH impedance state, regardless of what signals are present at the other inputs and the state of the storage elements.

The 74HC logic family is speed, function and pinout compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

Features

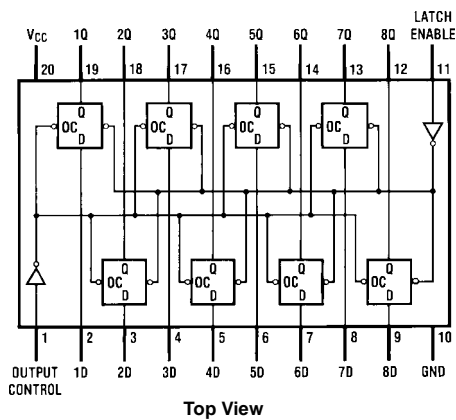
- Typical propagation delay: 18 ns
- Wide operating voltage range: 2 to 6 volts
- Low input current: 1 μ A maximum
- Low quiescent current: 80 μ A maximum (74HC Series)
- Compatible with bus-oriented systems
- Output drive capability: 15 LS-TTL loads

Ordering Code:

| Order Number | Package Number | Package Description |
|--------------|----------------|---|
| MM74HC573WM | M20B | 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide |
| MM74HC573SJ | M20D | 20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide |
| MM74HC573MTC | MTC20 | 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide |
| MM74HC573N | N20A | 20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide |

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



Truth Table

| Output Control | Latch Enable | Data | Output |
|----------------|--------------|------|--------|
| L | H | H | H |
| L | H | L | L |
| L | L | X | Q_0 |
| H | X | X | Z |

H = HIGH Level
L = LOW Level
 Q_0 = Level of output before steady-state input conditions were established.
Z = High Impedance
X = Don't Care

Absolute Maximum Ratings (Note 1)

(Note 2)

| | |
|--|-----------------------|
| Supply Voltage (V_{CC}) | -0.5 to +7.0V |
| DC Input Voltage (V_{IN}) | -1.5 to $V_{CC}+1.5V$ |
| DC Output Voltage (V_{OUT}) | -0.5 to $V_{CC}+0.5V$ |
| Clamp Diode Current (I_{IK}, I_{OK}) | ± 20 mA |
| DC Output Current, per pin (I_{OUT}) | ± 35 mA |
| DC V_{CC} or GND Current, per pin (I_{CC}) | ± 70 mA |
| Storage Temperature Range (T_{STG}) | -65°C to +150°C |
| Power Dissipation (P_D) | |
| (Note 3) | 600 mW |
| S.O. Package only | 500 mW |
| Lead Temperature (T_L) | |
| (Soldering 10 seconds) | 260°C |

Recommended Operating Conditions

| | Min | Max | Units |
|---|-----|----------|-------|
| Supply Voltage (V_{CC}) | 2 | 6 | V |
| DC Input or Output Voltage (V_{IN}, V_{OUT}) | 0 | V_{CC} | V |
| Operating Temperature Range (T_A) | -40 | +85 | °C |
| Input Rise or Fall Times (t_r, t_f) | | | |
| $V_{CC} = 2.0V$ | | 1000 | ns |
| $V_{CC} = 4.5V$ | | 500 | ns |
| $V_{CC} = 6.0V$ | | 400 | ns |

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur.

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: -12 mW/°C from 65°C to 85°C.

DC Electrical Characteristics (Note 4)

| Symbol | Parameter | Conditions | V_{CC} | $T_A = 25^\circ\text{C}$ | | $T_A = -40$ to 85°C | $T_A = -55$ to 125°C | Units |
|-----------------|--|---|----------|--------------------------|-------------------|-----------------------------------|------------------------------------|---------------|
| | | | | Typ | Guaranteed Limits | | | |
| V_{IH} | Minimum HIGH Level Input Voltage | | 2.0V | | 1.5 | 1.5 | 1.5 | V |
| | | | 4.5V | | 3.15 | 3.15 | 3.15 | V |
| | | | 6.0V | | 4.2 | 4.2 | 4.2 | V |
| V_{IL} | Maximum LOW Level Input Voltage | | 2.0V | | 0.5 | 0.5 | 0.5 | V |
| | | | 4.5V | | 1.35 | 1.35 | 1.35 | V |
| | | | 6.0V | | 1.8 | 1.8 | 1.8 | V |
| V_{OH} | Minimum HIGH Level Output Voltage | $V_{IN} = V_{IH}$ or V_{IL} $ I_{OUT} \leq 20 \mu\text{A}$ | 2.0V | 2.0 | 1.9 | 1.9 | 1.9 | V |
| | | | 4.5V | 4.5 | 4.4 | 4.4 | 4.4 | V |
| | | | 6.0V | 6.0 | 5.9 | 5.9 | 5.9 | V |
| | | $V_{IN} = V_{IH}$ or V_{IL} $ I_{OUT} \leq 6.0$ mA $ I_{OUT} \leq 7.8$ mA | 4.5V | 4.2 | 3.98 | 3.84 | 3.7 | V |
| | | | 6.0V | 5.7 | 5.48 | 5.34 | 5.2 | V |
| | | | | | | | | |
| V_{OL} | Maximum LOW Level Output Voltage | $V_{IN} = V_{IH}$ or V_{IL} $ I_{OUT} \leq 20 \mu\text{A}$ | 2.0V | 0 | 0.1 | 0.1 | 0.1 | V |
| | | | 4.5V | 0 | 0.1 | 0.1 | 0.1 | V |
| | | | 6.0V | 0 | 0.1 | 0.1 | 0.1 | V |
| | | $V_{IN} = V_{IH}$ or V_{IL} $ I_{OUT} \leq 6.0$ mA $ I_{OUT} \leq 7.8$ mA | 4.5V | 0.2 | 0.26 | 0.33 | 0.4 | V |
| | | | 6.0V | 0.2 | 0.26 | 0.33 | 0.4 | V |
| | | | | | | | | |
| I_{IN} | Maximum Input Current | $V_{IN} = V_{CC}$ or GND | 6.0V | | ± 0.1 | ± 1.0 | ± 1.0 | μA |
| I_{OZ} | Maximum 3-STATE Output Leakage Current | $V_{OUT} = V_{CC}$ or GND $OC = V_{IH}$ | 6.0V | | ± 0.5 | ± 5.0 | ± 10 | μA |
| I_{CC} | Maximum Quiescent Supply Current | $V_{IN} = V_{CC}$ or GND $I_{OUT} = 0 \mu\text{A}$ | 6.0V | | 8.0 | 80 | 160 | μA |
| ΔI_{CC} | Quiescent Supply Current per Input Pin | $V_{CC} = 5.5V$ $V_{IN} = 2.4V$ or 0.4V (Note 4) | OE | 1.0 | 1.5 | 1.8 | 2.0 | mA |
| | | | LE | 0.6 | 0.8 | 1.0 | 1.1 | mA |
| | | | DATA | 0.4 | 0.5 | 0.6 | 0.7 | mA |

Note 4: For a power supply of $5V \pm 10\%$ the worst-case output voltages (V_{OH} , and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst-case V_{IH} and V_{IL} occur at $V_{CC} = 5.5V$ and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst-case leakage current (I_{IN} , I_{CC} , and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

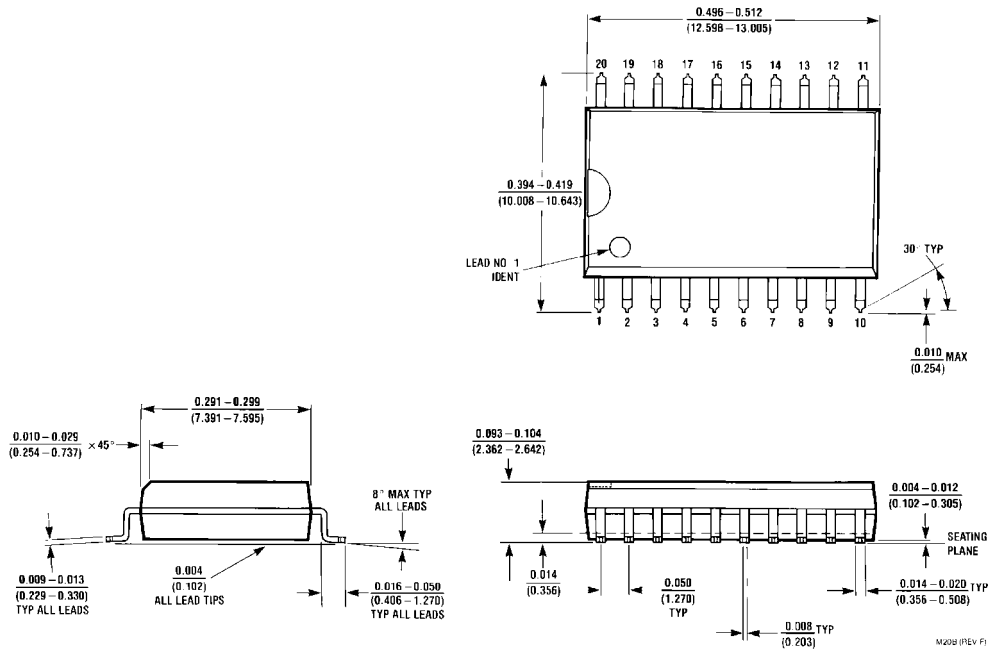
| AC Electrical Characteristics | | | | | | | | |
|---|--|------------------------------------|----------|--------------------|-------------------|------------------------------------|-------------------------------------|-------|
| $V_{CC} = 5V, T_A = 25^\circ C, t_r = t_f = 6 ns$ | | | | | | | | |
| Symbol | Parameter | Conditions | Typ | Guaranteed Limit | Units | | | |
| t_{PHL}, t_{PLH} | Maximum Propagation Delay, Data to Q | $C_L = 45 pF$ | 16 | 20 | ns | | | |
| t_{PHL}, t_{PLH} | Maximum Propagation Delay, LE to Q | $C_L = 45 pF$ | 14 | 22 | ns | | | |
| t_{PZH}, t_{PZL} | Maximum Output Enable Time | $R_L = 1 k\Omega$ $C_L = 45 pF$ | 15 | 27 | ns | | | |
| t_{PHZ}, t_{PLZ} | Maximum Output Disable Time | $R_L = 1 k\Omega$ $C_L = 5 pF$ | 13 | 23 | ns | | | |
| t_S | Minimum Set Up Time, Data to LE | | 10 | 15 | ns | | | |
| t_H | Minimum Hold Time, LE to Data | | 2 | 5 | ns | | | |
| t_W | Minimum Pulse Width, LE or Data | | 10 | 16 | ns | | | |
| AC Electrical Characteristics | | | | | | | | |
| Symbol | Parameter | Conditions | V_{CC} | $T_A = 25^\circ C$ | | $T_A = -40 \text{ to } 85^\circ C$ | $T_A = -55 \text{ to } 125^\circ C$ | Units |
| | | | | Typ | Guaranteed Limits | | | |
| t_{PHL}, t_{PLH} | Maximum Propagation Delay Data to Q | $C_L = 50 pF$ | 2.0V | 45 | 110 | 138 | 165 | ns |
| | | | 2.0V | 58 | 150 | 188 | 225 | ns |
| | | $C_L = 150 pF$ | 4.5V | 17 | 22 | 28 | 33 | ns |
| | | | 4.5V | 21 | 30 | 38 | 40 | ns |
| | | 6.0V | 15 | 19 | 24 | 29 | ns | |
| t_{PHL}, t_{PLH} | Maximum Propagation Delay, LE to Q | $C_L = 50 pF$ | 2.0V | 46 | 115 | 138 | 165 | ns |
| | | | 2.0V | 60 | 155 | 194 | 233 | ns |
| | | $C_L = 150 pF$ | 4.5V | 14 | 23 | 29 | 35 | ns |
| | | | 4.5V | 21 | 31 | 47 | 47 | ns |
| | | 6.0V | 12 | 20 | 25 | 30 | ns | |
| 6.0V | 19 | 27 | 34 | 41 | ns | | | |
| t_{PZH}, t_{PZL} | Maximum Output Enable Time | $R_L = 1 k\Omega$ | 2.0V | 55 | 140 | 175 | 210 | ns |
| | | | | | | | | |
| | | $C_L = 150 pF$ | 2.0V | 67 | 180 | 225 | 270 | ns |
| | | | 4.5V | 15 | 28 | 35 | 42 | ns |
| | | 4.5V | 24 | 36 | 45 | 54 | ns | |
| t_{PHZ}, t_{PLZ} | Maximum Output Disable Time | $R_L = 1 k\Omega$ | 2.0V | 40 | 125 | 156 | 188 | ns |
| | | | 4.5V | 13 | 25 | 31 | 38 | ns |
| | | 6.0V | 12 | 21 | 27 | 32 | ns | |
| t_S | Minimum Set Up Time Data to LE | | 2.0V | 30 | 75 | 95 | 110 | ns |
| | | | 4.5V | 10 | 15 | 19 | 22 | ns |
| | | | 6.0V | 9 | 13 | 16 | 19 | ns |
| t_H | Minimum Hold Time LE to Data | | 2.0V | | 25 | 31 | 38 | ns |
| | | | 4.5V | | 5 | 6 | 7 | ns |
| | | | 6.0V | | 4 | 5 | 6 | ns |
| t_W | Minimum Pulse Width LE, or Data | | 2.0V | 30 | 80 | 100 | 120 | ns |
| | | | 4.5V | 9 | 16 | 20 | 24 | ns |
| | | | 6.0V | 8 | 14 | 18 | 20 | ns |
| t_{TLH}, t_{THL} | Maximum Output Rise and Fall Time, Clock | $C_L = 50 pF$ | 2.0V | 25 | 60 | 75 | 90 | ns |
| | | | 4.5V | 7 | 12 | 15 | 18 | ns |
| | | | 6.0V | 6 | 10 | 13 | 15 | ns |
| C_{PD} | Power Dissipation Capacitance (Note 5) (per latch) | $OC = V_{CC}$ | | 5 | | | | pF |
| | | $OC = GND$ | | 52 | | | | pF |
| C_{IN} | Maximum Input Capacitance | | | 5 | 10 | 10 | 10 | pF |

AC Electrical Characteristics (Continued)

| Symbol | Parameter | Conditions | V _{CC} | T _A = 25°C | | T _A = -40 to 85°C | T _A = -55 to 125°C | Units |
|------------------|----------------------------|------------|-----------------|-----------------------|-------------------|------------------------------|-------------------------------|-------|
| | | | | Typ | Guaranteed Limits | | | |
| C _{OUT} | Maximum Output Capacitance | | | 15 | 20 | 20 | 20 | pF |

Note 5: C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption, $I_S = C_{PD} V_{CC} f + I_{CC}$.

Physical Dimensions inches (millimeters) unless otherwise noted

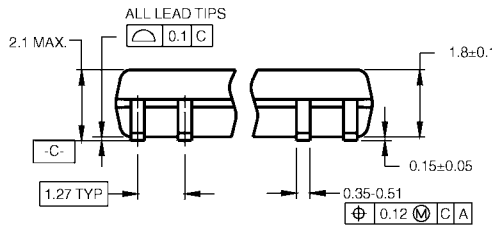


**20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
Package Number M20B**

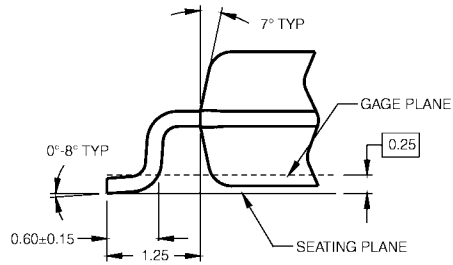
Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



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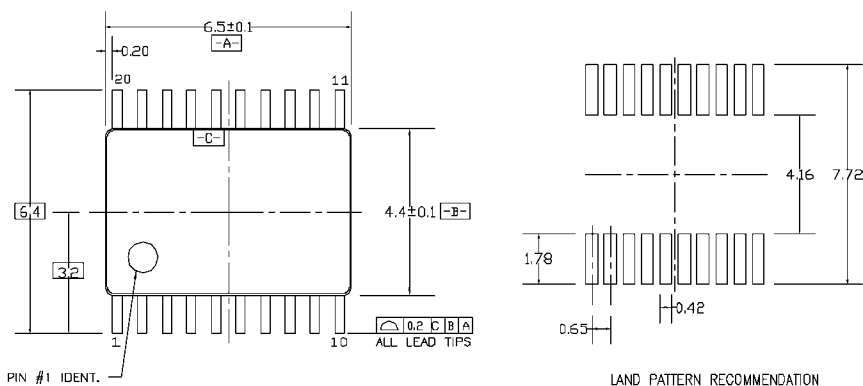
DETAIL A

- NOTES:
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 B. DIMENSIONS ARE IN MILLIMETERS.
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M20DRevB1

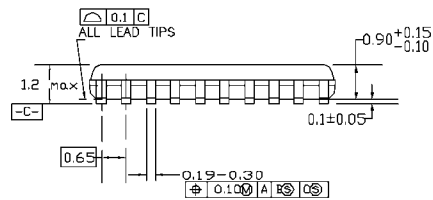
20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide Package Number M20D

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

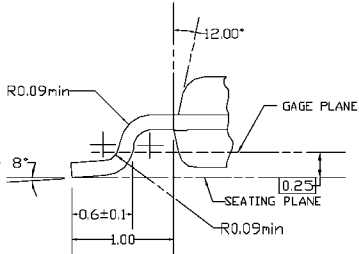
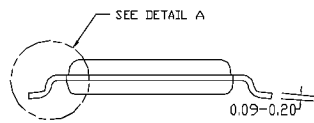


PIN #1 IDENT.

LAND PATTERN RECOMMENDATION



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DETAIL A

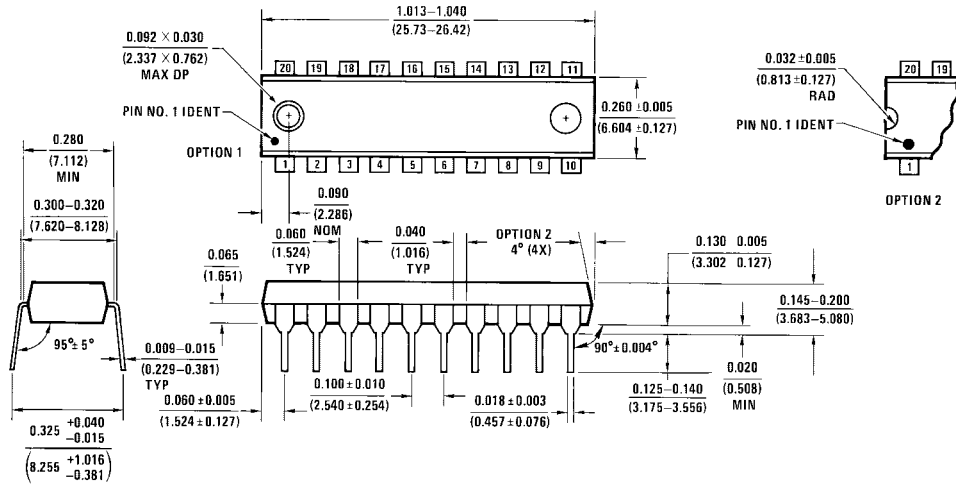
NOTES:

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- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLDS FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MTC20REVD1

**20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
Package Number MTC20**

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide
Package Number N20A

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